## **PRODUCT / PROCESS CHANGE INFORMATION**

| 1. PCI basic data    |  |  |  |
|----------------------|--|--|--|
| 1.1 Company          |  | STMicroelectronics International N.V                                       |  |
| 1.2 PCI No.          |  | MDG/22/13368   |  |
| 1.3 Title of PCI     |  | STM32H74x & STM32H75x 2MB product BootLoader & secure firmware improvement |  |
| 1.4 Product Category |  | STM32H74x,<br>STM32H75x  |  |
| 1.5 Issue date       |  | 2022-06-28   |  |

| 2. PCI Team               |                            |  |
|---------------------------|----------------------------|--|
| 2.1 Contact supplier      |                            |  |
| 2.1.1 Name                | NEMETH KRISZTINA           |  |
| 2.1.2 Phone               | +49 89460062210            |  |
| 2.1.3 Email               | krisztina.nemeth@st.com    |  |
| 2.2 Change responsibility |                            |  |
| 2.2.1 Product Manager     | Ricardo Antonio DE SA EARP |  |
| 2.1.2 Marketing Manager   | Veronique BARLATIER        |  |
| 2.1.3 Quality Manager     | Pascal NARCHE              |  |

| 3. Change    |   |                            |
|--------------|---|----------------------------|
| 3.1 Category | 3.2 Type of change  | 3.3 Manufacturing Location |
|              | Firmware modification : firmware is<br>programed in the memory without effect of<br>electrical performance at the customer (bug<br>fix) | Crolles (France)           |

| 4. Description of change  |   |   |
|---|---|---|
|   | Old   | New   |
| 4.1 Description   | Documents Current Revision<br>AN2606 - STM32 microcontroller system<br>memory boot mode - Rev54 April 2022                              | Documents New Revision<br>AN2606 - STM32 microcontroller system<br>memory boot mode - Rev55 June 2022 |
| 4.2 Anticipated Impact on form,fit,<br>function, quality, reliability or<br>processability? | No change on product<br>Revision update – impact on customer if check on revision is done (it might impact customer<br>production flow) |   |

| 5. Reason / motivation for change   |                     |  |
|---|---------------------|--|
| 5.1 Motivation To improve the SFI (Secure Firmware Install) functionality and the associated user exper |                     |  |
| 5.2 Customer Benefit  | SERVICE IMPROVEMENT |  |

| 6. Marking of parts / traceability of change                                |  |
|---|--|
| 6.1 Description Traceability of the change is ensured by ST internal tools. |  |

| 7. Timing / schedule                |                |
|-------------------------------------|----------------|
| 7.1 Date of qualification results   | 2022-08-18     |
| 7.2 Intended start of delivery      | 2022-09-22     |
| 7.3 Qualification sample available? | Not Applicable |

| 8. Qualification / Validation                         |             |               |  |
|---|-------------|---------------|--|
| 8.1 Description                                       |             |               |  |
| 8.2 Qualification report and<br>qualification results | In progress | Issue<br>Date |  |

9. Attachments (additional documentations)

13368 Public product.pdf

| 10. Affected parts      |                         |                          |  |  |
|-------------------------|-------------------------|--------------------------|--|--|
|                         | 10. 1 Current           | 10.2 New (if applicable) |  |  |
| 10.1.1 Customer Part No | 10.1.2 Supplier Part No | 10.1.2 Supplier Part No  |  |  |
|                         | STM32H742IIT6           |                          |  |  |
|                         | STM32H743AII6           |                          |  |  |
|                         | STM32H743BIT6           |                          |  |  |
|                         | STM32H743IIT6           |                          |  |  |
|                         | STM32H743VIT6           |                          |  |  |
|                         | STM32H743ZIT6           |                          |  |  |
|                         | STM32H745IIK6           |                          |  |  |
|                         | STM32H745IIT6           |                          |  |  |
|                         | STM32H745XIH3           |                          |  |  |
|                         | STM32H745XIH6           |                          |  |  |
|                         | STM32H745ZIT6           |                          |  |  |
|                         | STM32H747XIH6           |                          |  |  |
|                         | STM32H750IBK6           |                          |  |  |
|                         | STM32H750VBT6           |                          |  |  |
|                         | STM32H750ZBT6           |                          |  |  |
|                         | STM32H753BIT6           |                          |  |  |
|                         | STM32H753VIT6           |                          |  |  |
|                         | STM32H757XIH6           |                          |  |  |

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